

January 7, 1998

TEL:805-498-2111 FAX:805-498-3804 WEB:<http://www.semtech.com>AXIAL LEADED HERMETICALLY SEALED
SUPERFAST RECTIFIER DIODEQUICK
REFERENCE DATA

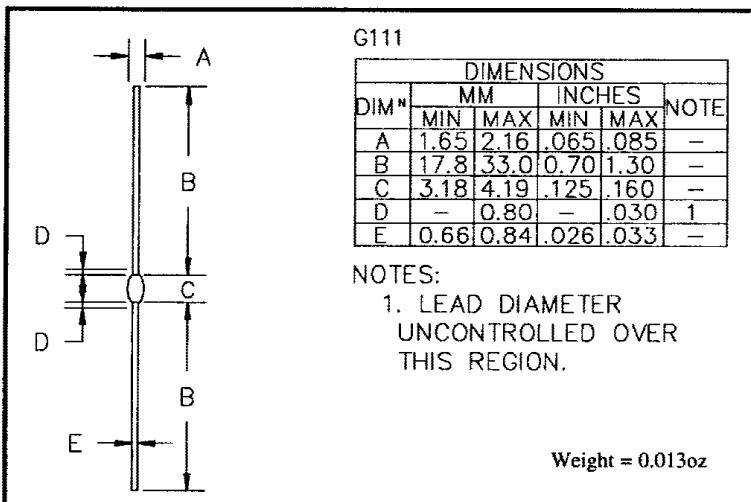
- Very low reverse recovery time
- Hermetically sealed in Metoxilite fused metal oxide
- Low switching losses
- Soft, non-snap off, recovery characteristics
- Very low forward voltage drop

- $V_R = 50 - 150V$
- $I_F = 2.5A$
- $t_{rr} = 25nS$
- $I_R = 1\mu A$

ABSOLUTE MAXIMUM RATINGS (@ 25°C unless otherwise specified)

	Symbol	1N5802	1N5804	1N5806	Unit
Working reverse voltage	V_{RWM}	50	100	150	V
Repetitive reverse voltage	V_{RRM}	50	100	150	V
Average forward current (@ 75°C, lead length = 0.375")	$I_{F(AV)}$	2.5	2.5	2.5	A
Repetitive surge current (@ 55°C in free air, lead length 0.375")	I_{FRM}	14	14	14	A
Non-repetitive surge current ($t_p = 8.3mS$, @ V_R & T_{jmax})	I_{FSM}	35	35	35	A
Storage temperature range	T_{STG}	-65 to +200	-65 to +200	-65 to +200	°C
Operating temperature range	T_{OP}	-65 to +175	-65 to +175	-65 to +175	°C

MECHANICAL



These products are qualified to MIL-S-19500/477 and are preferred parts as listed in MIL-STD-701. They can be supplied fully released as JANTX and JANTXV versions.

January 7, 1998

ELECTRICAL CHARACTERISTICS (@ 25°C unless otherwise specified)

	Symbol	1N5802	1N5804	1N5806	Unit
Average forward current max. (pcb mounted; T _A = 55°C) for sine wave for square wave (d = 0.5)	I _{F(AV)} I _{F(AV)}	1.3 1.4			A A
Average forward current max. (T _L = 55°C; L = 3/8") for sine wave for square wave	I _{F(AV)} I _{F(AV)}	3.1 3.3			A A
I ² t for fusing (t = 8.3mS) max.	I ² t	10.0			A ² S
Forward voltage drop max. @ I _F = 1.0A, T _j = 25°C	V _F	0.875			V
Reverse current max. @ V _{RWM} , T _j = 25°C @ V _{RWM} , T _j = 100°C	I _R I _R	1.0 50			µA µA
Reverse recovery time max. 1.0A I _F to 1.0A I _R . Recovers to 0.1A I _{RR} .	t _{rr}	25			nS
Junction capacitance typ. @ V _R = 5V, f = 1MHz	C _j	25			pF

THERMAL CHARACTERISTICS

	Symbol	1N5802	1N5804	1N5806	Unit
Thermal resistance - junction to lead Lead length = 0.75"	R _{θJL}	59			°C/W
Thermal resistance - junction to amb. on 0.06" thick pcb. 1 oz. copper.	R _{θJA}	100			°C/W

January 7, 1998

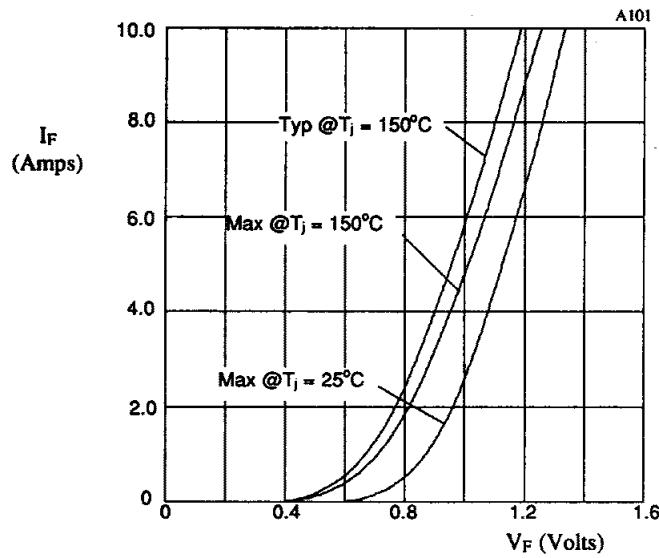


Fig 1. Forward voltage drop as a function of forward current.

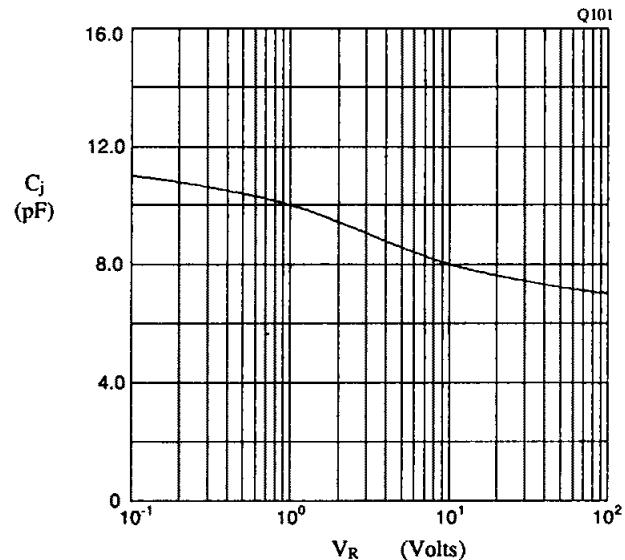


Fig 2. Typical junction capacitance as a function of reverse voltage.